

## 54FCT541

### Octal Buffer/Line Driver with TRI-STATE® Outputs

#### General Description

The 'FCT541 is an octal buffer and line driver with TRI-STATE outputs designed to be employed as a memory and address driver, clock driver, or bus-oriented transmitter/receiver. The 'FCT541 is similar to the 'FCT244 with broad-side pinout.

- TTL input and output level compatible
- CMOS power consumption
- Output sink capability of 48 mA, source capability of 12 mA
- Flow-through pinout for ease of PC board layout
- Standard Microcircuit Drawing (SMD) 5962-8976601

#### Features

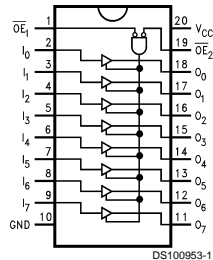
- Non-inverting buffers

#### Ordering Code

Military	Package Number	Package Description
54FCT541DMQB	J20A	20-Lead Ceramic Dual-In-Line
54FCT541FMQB	W20A	20-Lead Cerpack
54FCT541LMQB	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C

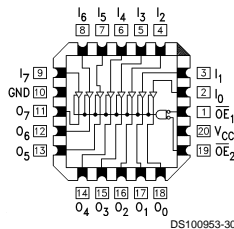
#### Connection Diagram

Pin Assignment  
DIP and Cerpack



DS100953-1

Pin Assignment  
LCC



DS100953-30

Pin Names	Description
$\overline{OE}_1, \overline{OE}_2$	Output Enable Input (Active Low)
$I_0-I_7$	Inputs
$O_0-O_7$	Outputs

#### Truth Table

Inputs			Outputs
$\overline{OE}_1$	$\overline{OE}_2$	I	FCT541
L	L	H	H
H	X	X	Z
X	H	X	Z
L	L	L	L

H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Immaterial  
Z = High Impedance

## Absolute Maximum Ratings (Note 1)

Storage Temperature	–65°C to +150°C
Ambient Temperature under Bias	–55°C to +125°C
Junction Temperature under Bias	
Ceramic	–55°C to +175°C
V <sub>CC</sub> Pin Potential to Ground Pin	–0.5V to +7.0V
Input Voltage (Note 2)	–0.5V to +7.0V
Input Current (Note 2)	–30 mA to +5.0 mA
Voltage Applied to Any Output in the Disabled or Power-Off State	–0.5V to 5.5V
in the HIGH State	–0.5V to V <sub>CC</sub>
Current Applied to Output	

in LOW State (Max)	twice the rated I <sub>OL</sub> (mA)
DC Latchup Source Current	–500 mA
Over Voltage Latchup (I/O)	10V

## Recommended Operating Conditions

Free Air Ambient Temperature	
Military	–55°C to +125°C
Supply Voltage	
Military	+4.5V to +5.5V
Minimum Input Edge Rate	(ΔV/Δt)
Data Input	50 mV/ns
Enable Input	20 mV/ns

## DC Electrical Characteristics

Symbol	Parameter	FCT541			Units	V <sub>CC</sub>	Conditions
		Min	Typ	Max			
V <sub>IH</sub>	Input HIGH Voltage	2.0			V		Recognized HIGH Signal
V <sub>IL</sub>	Input LOW Voltage		0.8		V		Recognized LOW Signal
V <sub>CD</sub>	Input Clamp Diode Voltage		–1.2		V	Min	I <sub>IN</sub> = –18 mA
V <sub>OH</sub>	Output HIGH Voltage	54FCT	4.3		V	Min	I <sub>OH</sub> = –300 μA
		54FCT	2.4		V	Min	I <sub>OH</sub> = –12 mA
V <sub>OL</sub>	Output LOW Voltage	54FCT	0.2		V	Min	I <sub>OL</sub> = 300 μA
		54FCT	0.55		V	Min	I <sub>OL</sub> = 48 mA
I <sub>IH</sub>	Input HIGH Current		5		μA	Max	V <sub>IN</sub> = V <sub>CC</sub>
I <sub>IL</sub>	Input LOW Current		–5		μA	Max	V <sub>IN</sub> = 0.0V
I <sub>OZH</sub>	Output Leakage Current		10		μA	Max	V <sub>OUT</sub> = 5.5V; $\overline{OE}_n$ = 2.0V
I <sub>OZL</sub>	Output Leakage Current		–10		μA	Max	V <sub>OUT</sub> = 0.0V; $\overline{OE}_n$ = 2.0V
I <sub>OS</sub>	Output Short-Circuit Current		–60		mA	Max	V <sub>OUT</sub> = 0.0V
I <sub>CCQ</sub>	Quiescent Power Supply Current		1.5		mA	Max	V <sub>IN</sub> < 0.2V or V <sub>IN</sub> 5.3V, V <sub>CC</sub> = 5.5V
ΔI <sub>CC</sub>	Quiescent Power Supply Current		2.0		mA	Max	V <sub>I</sub> = V <sub>CC</sub> – 2.1V
I <sub>CCD</sub>	Dynamic I <sub>CC</sub>		0.4		mA/MHz	Max	V <sub>CC</sub> = 5.5V, Outputs Open, One Bit Toggling, 50% Duty Cycle, $\overline{OE}_n$ = GND
I <sub>CC</sub>	Total Power Supply Current		6.0		mA	Max	V <sub>CC</sub> = 5.5V, Outputs Open, f <sub>I</sub> = 10MHz, $\overline{OE}_n$ = GND, One Bit Toggling, 50% Duty Cycle, $\overline{OE}_n$ = GND

**Note 1:** Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

**Note 2:** Either voltage limit or current limit is sufficient to protect inputs.

## AC Electrical Characteristics

Symbol	Parameter	54FCT		Units	Fig. No.
		T <sub>A</sub> = –55°C to +125°C			
		V <sub>CC</sub> = 4.5V–5.5V			
		C <sub>L</sub> = 50 pF			
		Min	Max		
t <sub>PLH</sub>	Propagation Delay	2.0	9.0	ns	Figure 4

## AC Electrical Characteristics (Continued)

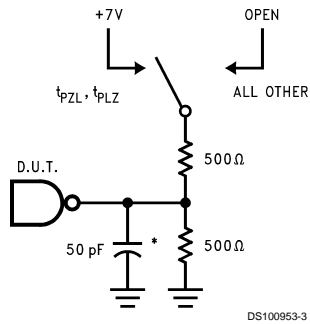
Symbol	Parameter	54FCT		Units	Fig. No.
		T <sub>A</sub> = -55°C to +125°C V <sub>CC</sub> = 4.5V-5.5V C <sub>L</sub> = 50 pF			
		Min	Max		
t <sub>PHL</sub>	Data to Outputs	2.0	9.0		
t <sub>PZH</sub>	Output Enable Time	2.0	12.5	ns	Figure 5
t <sub>PZL</sub>		2.0	12.5		
t <sub>PHZ</sub>	Output Disable Time	2.0	12.5	ns	Figure 5
t <sub>PLZ</sub>		2.0	12.5		

## Capacitance

Symbol	Parameter	Max	Units	Conditions $T_A = 25^{\circ}\text{C}$
$C_{IN}$	Input Capacitance	10.0	pF	$V_{CC} = 0.0\text{V}$
$C_{OUT}$ (Note 3)	Output Capacitance	12.0	pF	$V_{CC} = 5.0\text{V}$

**Note 3:**  $C_{OUT}$  is measured at frequency of  $f = 1\text{ MHz}$ , per MIL-STD-883B, Method 3012.

## AC Loading



\*Includes jig and probe capacitance

FIGURE 1. Standard AC Test Load

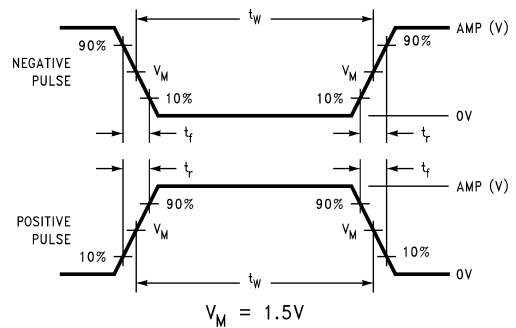


FIGURE 2. Test Input Signal Levels

Amplitude	Rep. Rate	$t_w$	$t_r$	$t_f$
3.0V	1 MHz	500 ns	2.5 ns	2.5 ns

FIGURE 3. Test Input Signal Requirements

## AC Waveforms

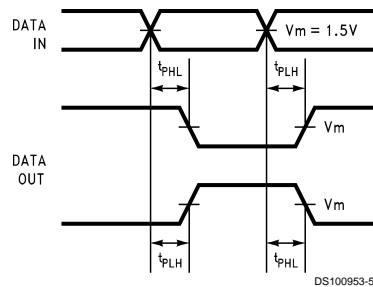


FIGURE 4. Propagation Delay Waveforms for Inverting and Non-Inverting Functions

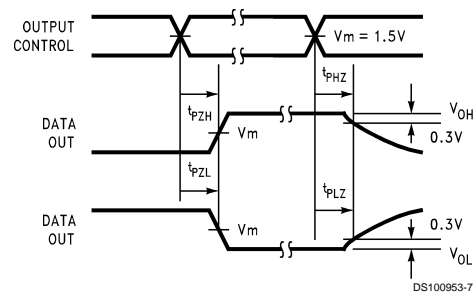
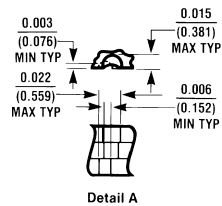
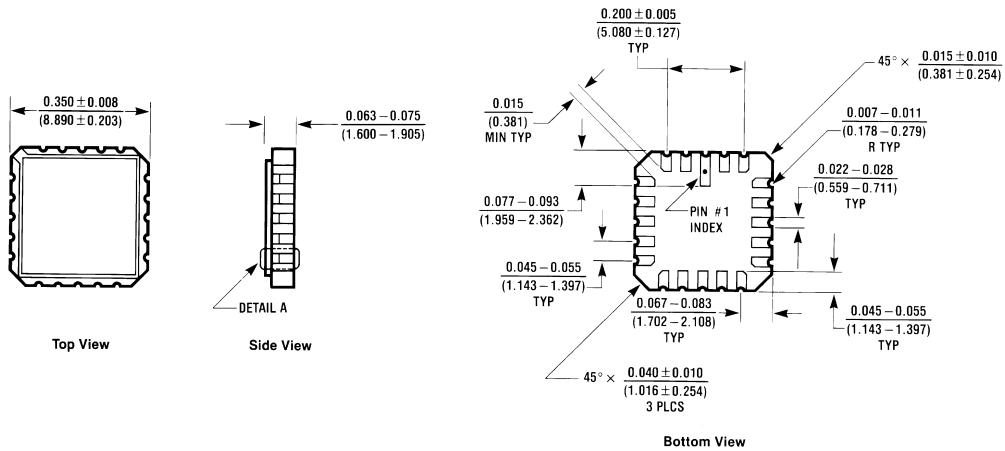


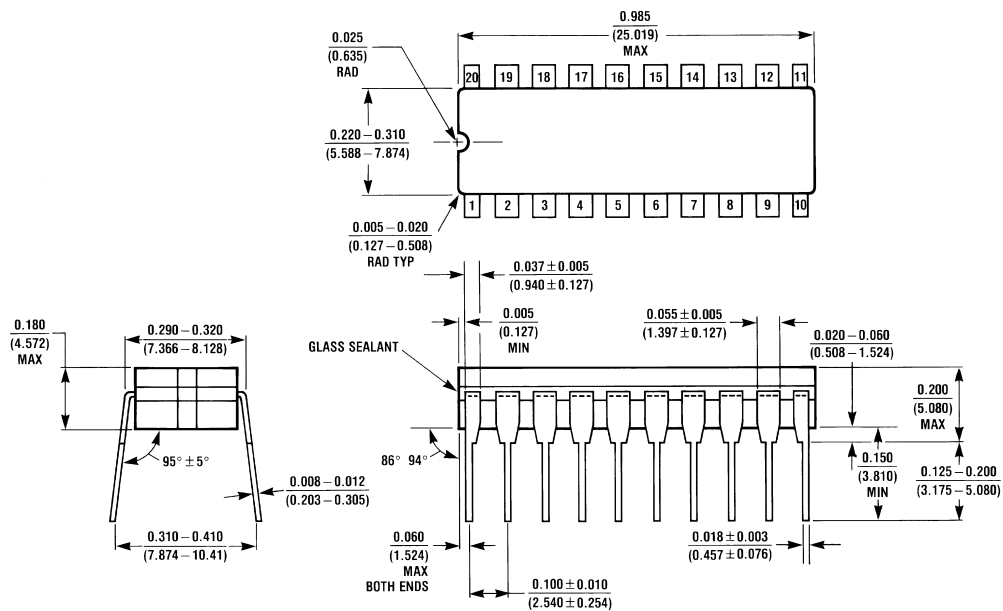
FIGURE 5. TRI-STATE Output HIGH and LOW Enable and Disable Time

## Physical Dimensions inches (millimeters) unless otherwise noted



E20A (REV D)

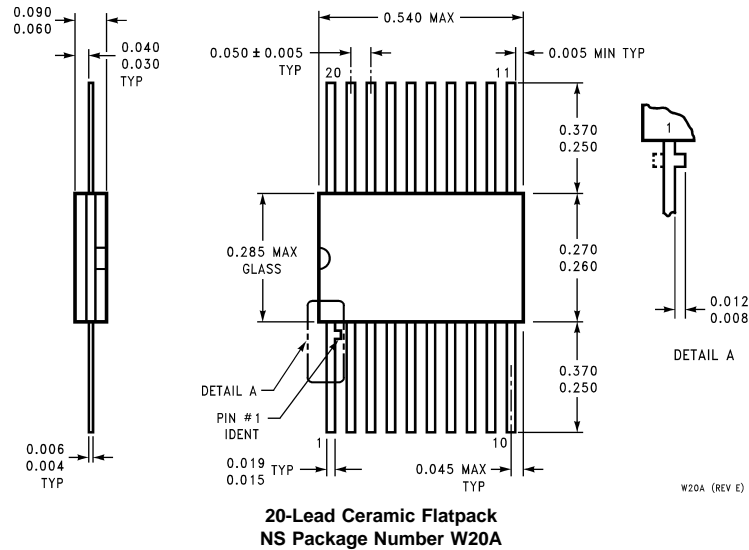
### 20-Terminal Ceramic Chip Carrier NS Package Number E20A



J20A (REV M)

### 20-Lead Ceramic Dual-In-Line Package NS Package Number J20A

# Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



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